

MOSFET - Power, N-Channel, SUPERFET® III, FAST

650 V, 49 A, 50 m Ω

NTBL050N65S3H

Description

SUPERFET III MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFAST III FAST MOSFET series helps minimize various power systems and improve system efficiency. The TOLL package offers improved thermal performance and excellent switching performance thanks to Kelvin Source configuration and lower parasitic source inductance. TOLL offers Moisture Sensitivity Level 1 (MSL 1).

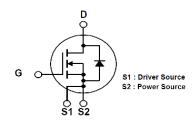
Features

- 700 V @ $T_J = 150$ °C
- Typ. $R_{DS(on)} = 40 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 98 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 909 pF)
- 100% Avalanche Tested
- Kelvin Source Configuration and Low Parasitic Source Inductance
- MSL1 Qualified
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
650 V	50 mΩ @ 10 V	49 A	

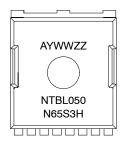


N-Channel MOSFET



H-PSOF8L CASE 100DC

MARKING DIAGRAM



A = Assembly Location
Y = Year
WW = Work Week
ZZ = Assembly Lot Code
NTBL050N65S3H = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Symbol	Parameter	Value	Unit	
V _{DSS}	Drain to Source Voltage		650	V
V _{GSS}	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
I _D	Drain Current	Continuous (T _C = 25°C)	49	Α
		Continuous (T _C = 100°C)	31	
I _{DM}	Drain Current	Pulsed (Note 1)	132	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		491	mJ
I _{AS}	Avalanche Current (Note 2)		6.8	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		3.05	mJ
dv/dt	MOSFET dv/dt		120	V/ns
	Peak Diode Recovery dv/dt (Note 3)	20		
P _D	Power Dissipation	(T _C = 25°C)	305	W
		Derate Above 25°C	2.44	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s		260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. $I_{AS} = 6.8 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 24.5 \text{ A}$, $di/dt \le 100 \text{ A}/\mu\text{s}$, $V_{DD} \le 400 \text{ V}$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case, Steady State	0.41	°CAM
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Steady State (Note 4)	43	°C/W

^{4.} Device on 1 in², 2 oz copper pad on 1.5 x 1.5 in. board of FR-4 material.

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Reel Size	Tape Width	Quantity
NTBL050N65S3H	NTBL050N65S3H	H-PSOF8L	13" mm	24 mm	2000 Units

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

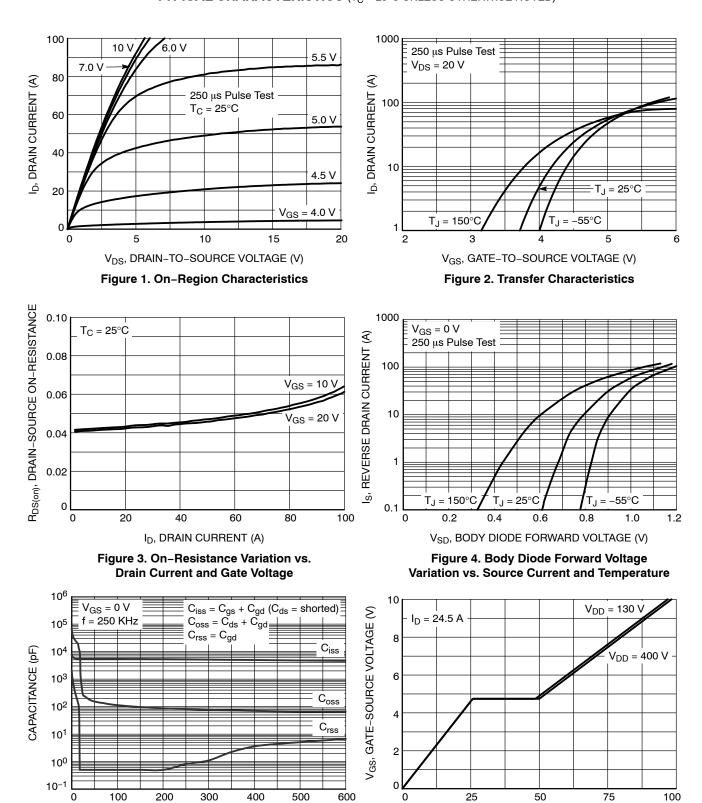
ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS		•	•	•	
BV _{DSS} Drain to Source	Drain to Source Breakdown Voltage	V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C	650	_	_	V
		V _{GS} = 0 V, I _D = 1 mA, T _J = 150°C	700	_	_	V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I _D = 10 mA, Referenced to 25°C	-	0.63	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 650 V, V _{GS} = 0 V	-	_	1.0	μА
		V _{DS} = 520 V, T _C = 125°C	-	3.21	-	
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±30 V, V _{DS} = 0 V	_	_	±100	nA
ON CHARACTE	RISTICS				•	
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 4.8 \text{ mA}$	2.4	_	4.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 24.5 A	_	42.5	50	mΩ
9FS	Forward Transconductance	V _{DS} = 20 V, I _D = 24.5 A	_	52	-	S
DYNAMIC CHA	RACTERISTICS			1		
C _{iss}	Input Capacitance	V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz	_	4880	_	pF
C _{oss}	Output Capacitance		_	70	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	-	909	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	-	128	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	$V_{DS} = 400 \text{ V}, I_D = 24.5 \text{ A}, V_{GS} = 10 \text{ V}$	-	98	-	nC
Q _{gs}	Gate to Source Gate Charge	(Note 5)	-	24	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	25	_	nC
ESR	Equivalent Series Resistance	f = 1 MHz	_	0.6	-	Ω
SWITCHING CH	IARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 400 V, I _D = 24.5 A,	_	32	_	ns
t _r	Turn-On Rise Time	V_{GS} = 10 V, R _g = 4.7 Ω (Note 5)	-	9.5	-	ns
t _{d(off)}	Turn-Off Delay Time		-	96	-	ns
t _f	Turn-Off Fall Time		_	2.6	-	ns
SOURCE-DRAI	N DIODE CHARACTERISTICS		•	•	•	
I _S	Maximum Continuous Source to Drain Diode Forward Current		_	_	49	Α
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current		-	_	132	Α
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 24.5 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 24.5 A,	-	442	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs	_	8.8	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS (T_C = 25°C UNLESS OTHERWISE NOTED)



V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

Figure 5. Capacitance Characteristics

 $\label{eq:Qg} \textbf{Q}_g, \, \text{TOTAL GATE CHARGE (nC)}$ Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (T_C = 25°C UNLESS OTHERWISE NOTED)

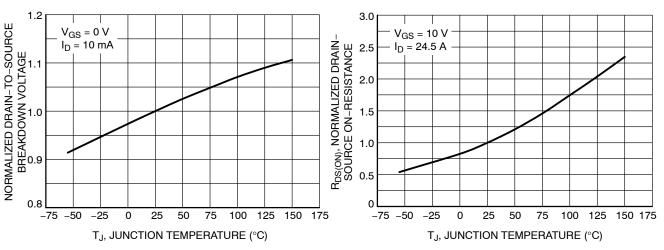


Figure 7. Breakdown Voltage Variation vs. Temperature

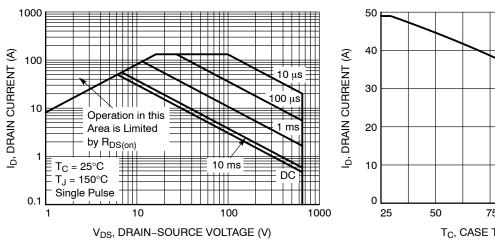


Figure 9. Maximum Safe Operating Area

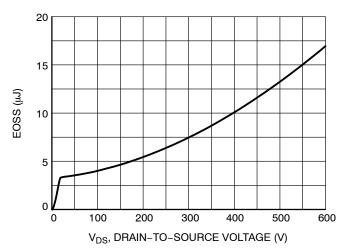


Figure 11. E_{OSS} vs. Drain to Source Voltage

Figure 8. On–Resistance Variation vs. Temperature

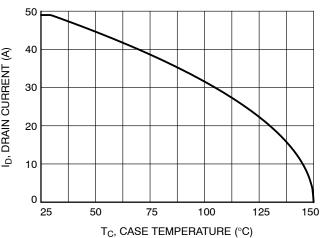


Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ UNLESS OTHERWISE NOTED)

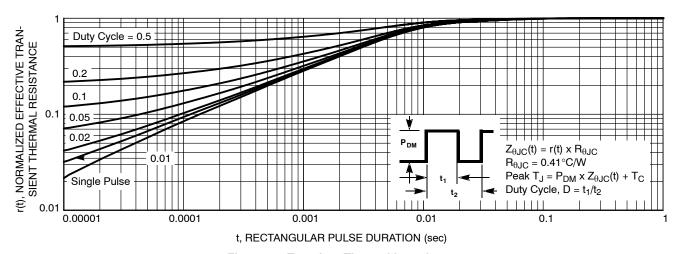


Figure 12. Transient Thermal Impedance

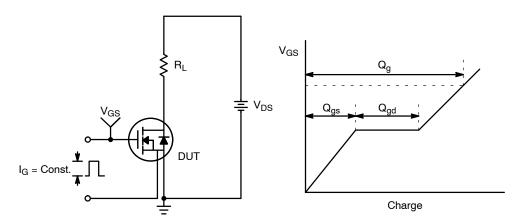


Figure 13. Gate Charge Test Circuit & Waveform

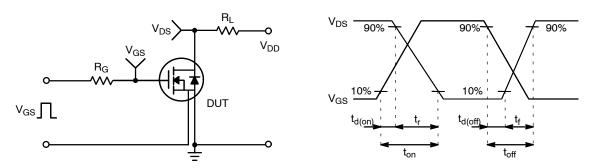


Figure 14. Resistive Switching Test Circuit & Waveforms

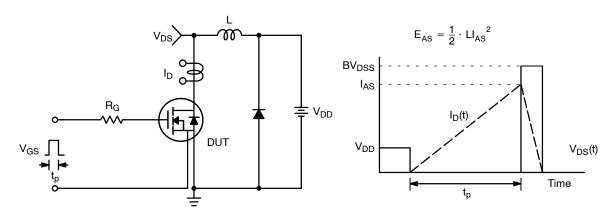


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

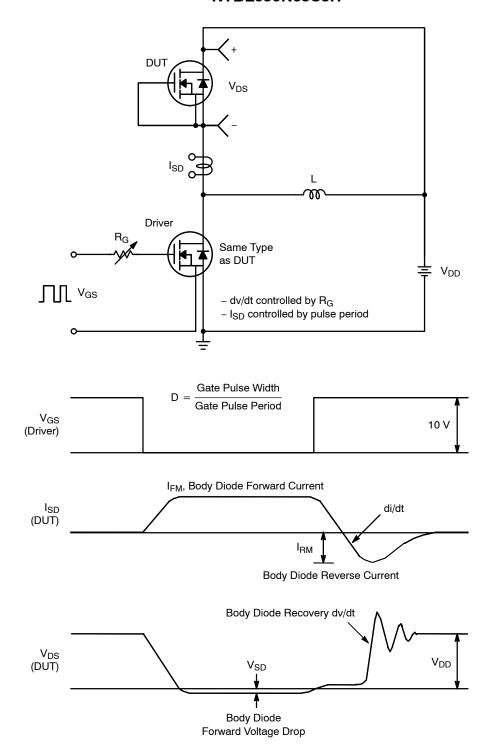
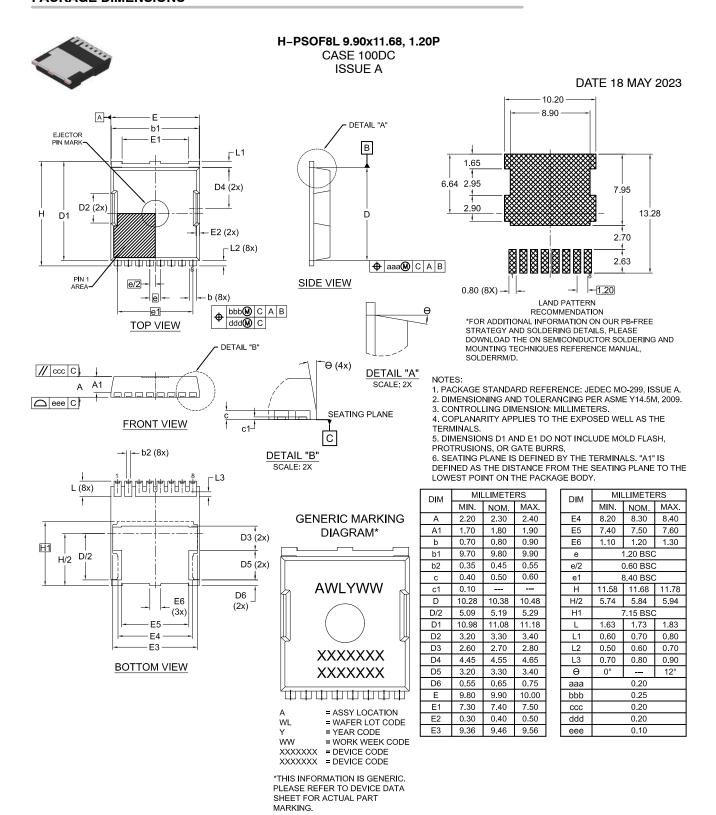


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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